

Fab Material Market

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Abstracts

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The future of the fab material market looks promising with opportunities in the automotive and communication sectors. The global fab material market is expected to grow with a CAGR of 4% to 6% from 2020 to 2025. The major drivers for this market is the growth of the semiconductor industry.

A total of XX figures / charts and XX tables are provided in more than 150 pages report is developed to help in your business decisions. Sample figures with some insights are shown below. To learn the scope, benefits, companies researched, and other details of the global fab material market report, please download the report brochure.

In this market, silicon is the largest product type of fab material, whereas communication is the largest end use indusry. Growth in various segments of the fab material market are given below:

The study includes trends and forecast for the global fab material market by type, and region as follows:

By Product Type [Value (\$ Million) shipment analysis for 2014 – 2025]:

Silicon SOIPahotomasks Photoresist Chemicals Others

By End Use Industry [Value (\$ Million) shipment analysis for 2014 – 2025]:

CommunicationAutomotiveConsumer ElectronicsIndustrialComputerOthers

By Region [Value (\$ Million) shipment analysis for 2014 – 2025]:



North AmericaUnited StatesCanada MexicoEuropeUnited
KingdomSpainGermanyFranceAsia PacificChinaIndiaJapanThe Rest of the World Brazil

Some of the fab material manufacturers profiled in this report include, Air Liquide, Hitachi, Fujimi, The Linde Group, Solvay, Soitec, Shin-Etsu Chemical Co., Ltd., Global Wafers Co., Ltd., SUMCO, Simgui, Global Foundries, STMicroelectronics N.V., Tower Jazz, NXP Semiconductors N.V., Murata Manufacturing, Skyworks Solutions, Qorvo, Sony Corporation, MagnaChip Semiconductor, United Microelectronics Corporation, Qualcomm Technologies, Inc., and Silicon Valley Microelectronics, Inc.

Lucintel forecast that silicon will remain the largest segment during the forecast period as silicon is fundamentally used in the building materials for semiconductors, which is a crucial component for all electronic goods and consumer electronics. The extensive use of silicon is because of its benefits such as low raw material cost, relatively simple processing, ease of availability, and a useful temperature range.

Within this market, communication is expected to remain the largest end use industy over the forecast period due to the growth of 5G.

Asia Pacific will remain the largest region and it is expected to witness the highest growth over the forecast period due to the growing demand for consumer electronics and electro-medical devices and the availability of raw materials, cheap labor, and favorable factors of production will boost the growth of the electronic goods market in this region.

Features of the Global Fab Material Market

Market Size Estimates: Global fab material market size estimation in terms of value (\$M) shipment. Trend and Forecast Analysis: Market trend (2014-2019) and forecast (2020-2025) by various segments and regions. Segmentation Analysis: Global fab material market size by various segments, such as product type and end use industry, in terms of value. Regional Analysis: Global fab material market breakdown by the North America, Europe, Asia Pacific, and Rest of the World. Growth Opportunities: Analysis of growth opportunities in different product type and end use industry, and region for the global fab material market. Strategic Analysis: This includes M&A, new product development, and competitive landscape of the global fab material market. Analysis of competitive intensity of the industry based on Porter's Five Forces model.



This report answers following key questions

- Q.1 What are some of the most promising potential, high-growth opportunities for the global fab material market by product type (silicon, SOI, pahotomasks, photoresist, chemicals, and others), end use industry (communication, computer, automotive, industrial, consumer electeonics, and others), and region (North America, Europe, Asia Pacific, and Rest of the World)?
- Q. 2 Which segments will grow at a faster pace and why?
- Q.3 Which region will grow at a faster pace and why?
- Q.4 What are the key factors affecting market dynamics? What are the drivers and challenges of the market?
- Q.5 What are the business risks and threats to the market?
- Q.6 What are emerging trends in this market and the reasons behind them?
- Q.7 What are some changing demands of customers in the market?
- Q.8 What are the new developments in the market? Which companies are leading these developments?
- Q.9 Who are the major players in this market? What strategic initiatives are being implemented by key players for business growth?
- Q.10 What are some of the competitive products and processes in this market, and how big of a threat do they pose for loss of market share via material or product substitution?
- Q.11 What M & A activities did take place in the last five years in this market?



Contents

1. EXECUTIVE SUMMARY

2. MARKET BACKGROUND AND CLASSIFICATION

- 2.1: Introduction, Background, and Classification
- 2.2: Supply Chain
- 2.3: Industry Drivers and Challenges

3. MARKET TRENDS AND FORECAST ANALYSIS FROM 2014 T 2025

- 3.1: Macroeconomic Trends and Forecast
- 3.2: Global Fab Material Market Trends and Forecast
- 3.3: Global Fab Material Market by Product Type
 - 3.3.1: Silicon
 - 3.3.2: SOI
 - 3.3.3: Pahotomasks
 - 3.3.4: Photoresist
 - 3.3.5: Chemicals
 - 3.3.6: Others
- 3.4: Global Fab Material Market by End Use Industry
 - 3.4.1: Communication
 - 3.4.2: Automotive
 - 3.4.3: Consumer Electronics
 - 3.4.4: Industrial
 - 3.4.5: Computer
 - 3.4.6: Others

4. MARKET TRENDS AND FORECAST ANALYSIS BY REGION

- 4.1: Global Fab Material Market by Region
- 4.2: North American Fab Material Market
- 4.2.1: Market by Product Type: Silicon, SOI, Pahotomasks, Photoresist, Chemicals, and Others
- 4.2.2: Market by End Use Industry: Communication, Computer, Automotive, Industrial, Consumer Electeonics, and Others
 - 4.2.3: United States Fab Material Market
- 4.2.4: Canadian Fab Material Market



- 4.2.5: Mexican Fab Material Market
- 4.3: European Fab Material Market
- 4.3.1: Market by Product Type: Silicon, SOI, Pahotomasks, Photoresist, Chemicals, and Others
- 4.3.2: Market by End Use Industry: Communication, Computer, Automotive, Industrial, Consumer Electeonics, and Others
 - 4.3.3: Germany Fab Material Market
 - 4.3.4: UK Fab Material Market
 - 4.3.5: France Fab Material Market
 - 4.3.6: Spain Fab Material Market
- 4.4: APAC Fab Material Market
- 4.4.1: Market by Product Type: Silicon, SOI, Pahotomasks, Photoresist, Chemicals, and Others
- 4.4.2: Market by End Use Industry: Communication, Computer, Automotive, Industrial, Consumer Electeonics, and Others
 - 4.4.3: China Fab Material Market
 - 4.4.4: Japan Fab Material Market
 - 4.4.5: South Korea Fab Material Market
 - 4.4.6: India Fab Material Market
- 4.5: ROW Fab Material Market
- 4.5.1: Market by Product Type: Silicon, SOI, Pahotomasks, Photoresist, Chemicals, and Others
- 4.5.2: Market by End Use Industry: Communication, Computer, Automotive, Industrial, Consumer Electeonics, and Others
 - 4.5.3: Brazil Fab Material Market

5. COMPETITOR ANALYSIS

- 5.1: Product Portfoli Analysis
- 5.2: Market Share Analysis
- 5.3: Operational Integration
- 5.4: Geographical Reach
- 5.5: Porter's Five Forces Analysis

6. GROWTH OPPORTUNITIES AND STRATEGIC ANALYSIS

- 6.1: Growth Opportunity Analysis
 - 6.1.1: Growth Opportunities for Global Fab Material Market by Product Type
 - 6.1.2: Growth Opportunities for Global Fab material Market by End Use Industry



- 6.1.3: Growth Opportunities for Global Fab material Market by Region
- 6.2: Emerging Trends in Global Fab Material Market
- 6.3: Strategic Analysis
 - 6.3.1: New Product Development
 - 6.3.2: Capacity Expansion of Global Fab Material Market
 - 6.3.3: Mergers, Acquisitions and Joint Ventures in the Global Fab Material Market

7. COMPANY PROFILES OF LEADING PLAYERS

- 7.1: Air Liquide
- 7.2: Hitachi
- 7.3: The Linde Group
- 7.4: Solvay
- 7.5: Shin-Etsu Chemical Co., Ltd
- 7.6: Global Wafers Co., Ltd.
- 7.7 SUMCO
- 7.8 Simgui
- 7.9 GlobalFoundries
- 7.10 STMicroelectronics N.V.
- 7.11 TowerJazz
- 7.12 NXP Semiconductors N.V.
- 7.13 Murata Manufacturing
- 7.14 Skyworks Solutions
- 7.15 Qorv
- 7.16 Sony Corporation
- 7.17 MagnaChip Semiconductor
- 7.18 United Microelectronics Corporation
- 7.19 Qualcomm Technologies, Inc.
- 7.20 Silicon Valley Microelectronics, Inc
- 7.21 Soitec
- 7.22 Fujimi



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